1 Characteristics

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Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit			
V _{RRM}	Repetitive peak reverse voltage	Repetitive peak reverse voltage				
V _{RMS}	Voltage rms	Voltage rms				
	Average forward current δ = 0.5, square wave DO-4	SMA	T _L = 125 °C		•	
IF(AV)		DO-41	T _L = 100 °C	- 1	A	
	I _{FSM} Surge non repetitive forward current DO-		t _n = 8.3 ms sinusoidal	18	Α	
IFSM			ι _p – σ.5 ms sinusoidai	20	A	
T _{stg}	Storage temperature range	-50 to +175	°C			
Тј	Maximum operating junction temperature	+175	°C			

Table 2. Thermal resistance parameter

Symbol		Max. value	Unit		
P	Junction to lead		SMA	30	
R _{th(j-l)}	Junction to lead	Logd length = 10 mm	DO 44	45	°C/W
R _{th(j-a)}	Junction to ambient	Lead length = 10 mm	DO-41	110	

For more information, please refer to the following application note :

AN5088 : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

	Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
[I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R = 1000 V	-		10	μA
			T _j = 125 °C		-		50	
	V _F ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 1 A	-		1.7	V
			T _j = 150 °C		-	0.98	1.42	v

1. Pulse test: $t_p = 5 ms, \, \delta < 2\%$

2. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses, use the following equation:

 $P = 1.20 \text{ x } I_{F(AV)} + 0.225 \text{ x } I_{F}^{2}(RMS)$

For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

Symbol	Parameters	Test conditions		Тур.	Max.	Unit
t _{rr}	Reverse recovery time	$I_F = 0.5 \text{ A}, I_{rr} = 0.25 \text{ A}, I_R = 1 \text{ A}$	-	-	75	ns
t _{fr}	Forward recovery time	I _F = 1 A, dI _F /dt = 50 A/µs, V _{FR} = 1.1 V _{F(max.)}		-	300	ns
V _{FP}	Forward recovery voltage			-	18	V

Table 4. Dynamic characteristics (T_j = 25 °C unless otherwise stated)

1.1 Characteristics (curves)

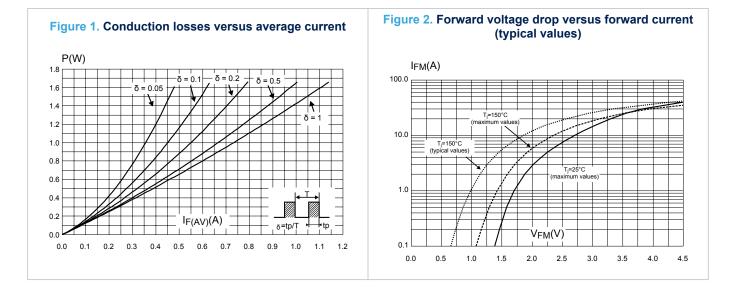
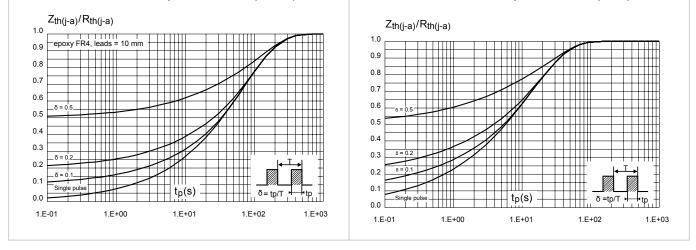


Figure 3. Relative variation of thermal impedance junction to ambient versus pulse duration (DO-41) Figure 4. Relative variation of thermal impedance junction to ambient versus pulse duration (SMA)





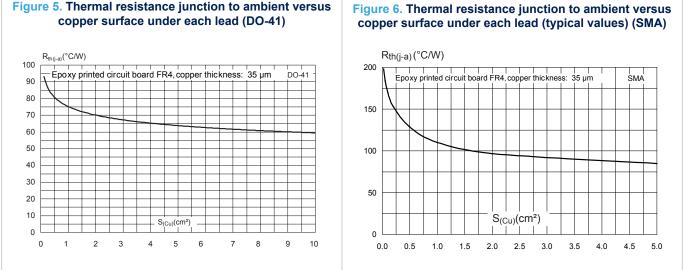


Figure 5. Thermal resistance junction to ambient versus

2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 DO-41 package information

- Epoxy meets UL 94, V0
- Band indicates cathode
- Bending method (DO-41): see Application note AN1471



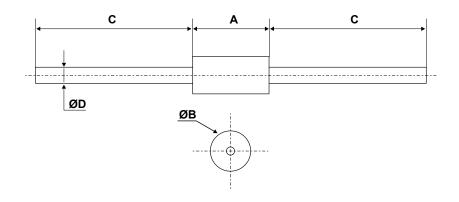


Table 5. DO-41 package mechanical data

	Dimensions							
Ref.	Millimeters			Inches (for reference only)				
	Min.	Тур.	Max.	Min.	Тур.	Max.		
A	4.07	-	5.20	0.160	-	0.205		
В	2.04	-	2.71	0.080	-	0.107		
С	25.40	-		1.000	-			
D	0.71	-	0.86	0.028	-	0.0034		

2.2 SMA package information

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- Epoxy meets UL94, V0
- Cooling method : by conduction (C)

Figure 8. SMA package outline

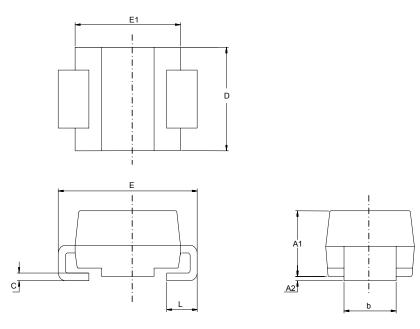
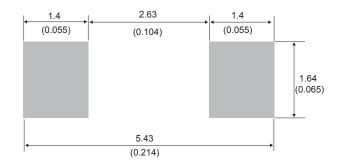


Table 6. SMA package mechanical data

	Dimensions						
Ref.	Millimeters		Inches (for re	ference only)			
	Min.	Max.	Min.	Max.			
A1	1.90	2.45	0.074	0.097			
A2	0.05	0.20	0.001	0.008			
b	1.25	1.65	0.049	0.065			
с	0.15	0.40	0.005	0.016			
D	2.25	2.90	0.088	0.115			
E	4.80	5.35	0.188	0.211			
E1	3.95	4.60	0.155	0.182			
L	0.75	1.50	0.029	0.060			





3 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH110	STTH110	DO-41	0.34 g	2000	Ammopack
STTH110A	H10	SMA	0.068 g	5000	Tape and reel 13"
STTH110RL	STTH110	DO-41	0.34 g	5000	Tape and reel 13"

Table 7. Ordering information

Revision history

Table 8. Document revision history

Date	Revision	Changes
Jan-2003	1	Initial release.
30-Sept-2009	2	Updated Table 8.
20-Dec-2013	3	Updated Table 4.
11-Dec-2019	4	Updated Table 3.



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